

#### ISO9001 & ISO14001 & TS16949 CHILISIN ELECTRONICS CORP.

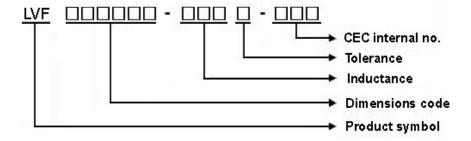
### Lead-Free & RoHs Compliance!!

# SPECIFICATION FOR APPROVAL

CUSTOMER:			
CUSTOMER P/N:			
OUR DWG No:			
QUANTITY:	0 Pc	cs. DATE:	2013/05/29
ITEM:		LVF505020-S	SERIES
	ODEOU		
		FICATION PTED BY:	
COMPONENT ENGINEER			
ELECTRICAL ENGINEER			
MECHANICAL ENGINEER			
APPROVED			
REJECTED			
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- 1 Scope: This specification applies to Wire Wound Power Inductors
- 2 Part Numbering: Product Identification

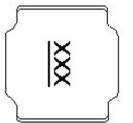


3 Rating:

**Operating Temperature:**  $-4.0 \, ^{\circ}\text{C} \sim 1.2.5 \, ^{\circ}\text{C}$  (Including self - temperature rise)

Storage Temperature:  $20 \, ^{\circ} \! \text{C} \sim 25 \, ^{\circ} \! \text{C}$  R.H.  $65 \, ^{\circ} \! \text{M}$  (For Reference)

4 Marking:



Ex: LVS505020-3R9M-N□□

Marking: 3R9

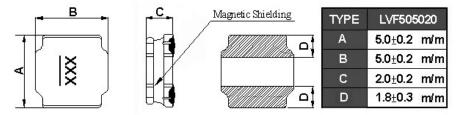
Marking color: Black

### 5 Standard Testing Condition

	Unless otherwise specified	In case of doubt
Temperature	Ordinary Temperature(15 to 35℃)	<b>20±2</b> ℃
Humidity	Ordinary Humidity(25 to 85% RH)	60 to 70 % RH



### 6 Configuration and Dimensions:



### 7 ELECTRICAL CHARACTERISTICS :

Part No.	Inductance (uH)	Test Freq.	RDC (mΩ)±30%	Isat(A) Typ.(Max)	Irms(A) Typ.(Max)	Tolerance (±%)	Marking
LVF505020-1R0□-NCO	1	100kHz,1V	18	6.0(5.40)	4.1(3.69)	20,30	1R0
LVF505020-1R5□-NCO	1.5	100kHz,1V	23	4.9(4.41)	3.5(3.15)	20,30	1R5
LVF505020-2R2 <sub>-</sub> NCO	2.2	100kHz,1V	30	4.0(3.60)	3.3(2.97)	20,30	2R2
LVF505020-3R9□-NCO	3.9	100kHz,1V	53	2.9(2.61)	2.6(2.34)	20,30	3R9
LVF505020-4R7 <sub>-</sub> -NCO	4.7	100kHz,1V	60	2.7(2.43)	2.2(1.98)	20,30	4R7
LVF505020-6R8□-NCO	6.8	100kHz,1V	93	2.2(1.98)	1.8(1.62)	20,30	6R8
LVF505020-100□-NCO	10	100kHz,1V	125	1.8(1.62)	1.6(1.44)	20,30	100
LVF505020-150 <sub>-</sub> NCO	15	100kHz,1V	195	1.4(1.26)	1.2(1.08)	20,30	150
LVF505020-220 <sub>□</sub> -NCO	22	100kHz,1V	265	1.2(1.08)	1.0(0.90)	20,30	220

NOTE: □-tolerance M=±20% / T=±30%

<sup>1.</sup> Operating temperature range  $-4~0~{\rm ^{\circ}C} \sim 1~2~5~{\rm ^{\circ}C}$  (Including self - temperature rise)

<sup>2.</sup>Isat for Inductance drop 30% from its value without current.

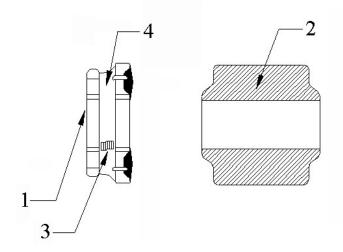
<sup>3.</sup>Irms for a  $40^{\circ}$ C rise above  $25^{\circ}$ C ambient.

<sup>&</sup>quot;-N" FOR COMPLETELY LEAD FREE TYPE(INCLUDING FERRITE BODY & SOLDER)



### 8 LVF505020 Series

### 8.1 Construction:



#### 8.2 Material List:

ITEM	PART	DESCRIPTION	SUPPLIES
1	CORE	FERRITE	CHILISIN
2	TERMINAL	Ag/Ni/Sn	
3	WIRE	Grade 180	ELEKTRISOLA
4	EPOXY	Magnetic powder resin	



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# **LVF505020 Series Specification**

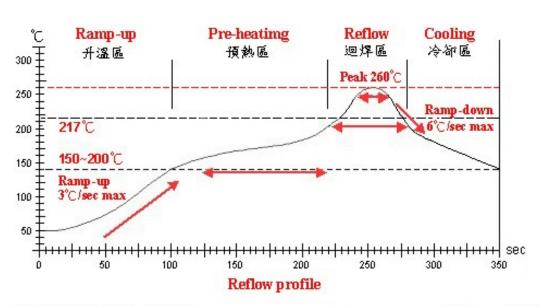
### 9 Reliability Of Wire Wound Power Inductors

### 1-1.Mechanical Performance

	Item	Specification	Test Method
1-1-1	Bending Test	Chip coil shall not be	Substrate:Glass-epoxy substrate(100mm*40mm*1.6mm)
		damaged after tested as test	speed of Applying Force:1mm/s
		method	Deflection:2mm
			Hold Duration:30s    F
1-1-2	Vibration		Oscillation Frequency:10Hz to 55 Hz to 10 hZ for 1 min Total Amplitude:1.5mm Testing Time:A period of 2 hours in each of 3 mutually
1 1 0	0.11.139		perpendicular directions(Total 6 hours)
1-1-3	Solderability	The wetting area of the electrode shall be at least 95% covered with new solder coating	Solder:Sn/Ag3.0/Cu0.5 per-Heating:150°C±10°C/1min to 2min solder Temperature:245°C±5°C Immersion Time:4s±1s
1-1-4	Resistance to Soldering Heat	Appearance:No damage	Solder:Sn/Ag3.0/Cu0.5 per-Heating:150℃±10℃/1min to 2min solder Temperature:260℃±5℃ Immersion Time:10s±1s
1-1-5	Resistance to solvent	There must be no change in appearance or obliteration of marking.	Inductors must withstand 6 minutes of alcohol or water.

#### 1-2 Environmental Performance

No	ltem	Specification		Test Method	
1-2-1	Heat Resistance	Appearance: No damage Inductance Change:within±10%	Temperature:125°C±3°C  7ime:500h  Then measured after exposure in the room		
				on for 24h±2h	
1-2-2	Cold Resistance		Time:5		
				neasured after exposure in the room on for 24h±2h	
1-2-3	Humidity		Temperature: 40°C±2°C Humidity:90%(RH) to 95%(RH)		
				บบท neasures after exposure in the room on for 24h±2h	
1-2-4	Temperature Cycle	1	One cy	rcle:	
			Step	Temperature ( $^{\circ}\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!$	Time (min)
			1	-40±3	30
			2	25±2	3
			3	125±3	30
			4 1	25±2	3
	Total: 100cycles				.
			IMeasu	red after exposure in the room condition for 2	4hrs



### Lead-Free(LF) 標準溫度分析範圍

Refer to J-STD-020C

管制項目 Item.	升溫區 Ramp-up	預熱區 Pre-heatimg	迴焊區 Reflow	Peak Temp	冷卻區 Cooling
溫度範圍 Temp.scope	R.T. ~150°C	150°C ~ 200°C	<b>21</b> 7℃	260±5°C	Peak Temp. ~ 150°C
標準時間 Time spec.	_	60 ~ 180 sec	60 ~ 150 sec	20 ~ 40 sec	-
實際時間 Time result	1 100	75 ~ 100 sec	90 ~ 120 sec	5 ~ 10 sec	_

### NOTE:

- 1. Re-flow possible times: within 2 times
- 2. Nitrogen adopted is recommended while in re-flow



## 11 PACKAGING

### 11.1 Packaging -Cover tape

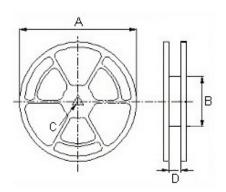
The force for tearing off cover tape is 10 to 130 grams in the arrow direction.



#### 11.2 Packaging Quantity

TYPE	BULK	PCS/REEL
LVF505020	<b>\</b>	2000

#### 11.3 Reel Dimensions



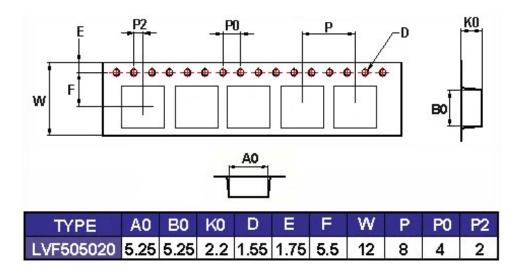
Reel Dimension: m/m

TYPE	A	В	С	О
LVF505020	330	100	13	13.4

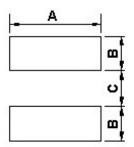


# 11 PACKAGING

#### 11.4 Tape Dimensions in mm



### 12 Recommended Pattern



Dimensions in mm

TYPE	A(m/m)	B(m/m)	C(m/m)
LVF505020	4.2	1.6	2.0

### 13 Note:

- 1. Please make sure that your product is has been evaluated and confirmed against your specifications when our product is mounted to your product.
- 2. Do not knock nor drop.
- 3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose,under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
- 4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)





#### 5. Storage and Handing Requirements

#### (1)Storage period

Use the products within 12 months after delivered Solderability should be checked if this period is exceeded

#### (2)Storage conditions

\*Products should be stored in the warehouse on the following conditions

Temperature: -10°C ~ 40°C

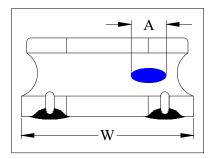
Humidity :  $30\% \sim 70\%$  relative humidity no rapid change on temperature and humidity The electrode of the products is coated with solder.Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solderability.

- \*Products should not be storaged on bulk packaging condition to prevent the chipping of the core and the breaking of winding wire caused by the collision between the products.
- \*Products should be storaged on the palette for the prevention of the influence from humidity, dust and so on.
- \*Products should be storaged in the warehouse without heat shock, vibration, direct sunlight and so on.

#### (3)Handing Condition

Care should be taken when transporting or handing product to avoid excessive vibration or mechanical shock.

6. Void Appearance tolerance Limit



A≤ W2 GOOD A> W2 NG